

#### **Product Change Notification / LIAL-26JIWI938**

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29-Sep-2023

## **Product Category:**

Wireless IC

## **PCN Type:**

Manufacturing Change

## **Notification Subject:**

CCB 5172 Final Notice: Qualification of UTL as a new assembly site for MICRF112YMU-TR catalog part number (CPN) available in 10L X2DFN (2x2x0.4mm) package.

#### **Affected CPNs:**

LIAL-26JIWI938\_Affected\_CPN\_09292023.pdf LIAL-26JIWI938\_Affected\_CPN\_09292023.csv

#### **Notification Text:**

**PCN Status:**Final Notification

**PCN Type:**Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of UTL as a new assembly site for MICRF112YMU-TR catalog part number (CPN) available in 10L X2DFN (2x2x0.4mm) package.

#### **Pre and Post Change Summary:**

	Pre Change	Post Change
Assembly Site	Unisem (M) Berhad	UTAC Thai Limited (UTL-1)

		Perak, Malaysia / (UNIS)	LTD. / (UTL)			
Wire Material		Au	Au			
Die Att	ach Material	CRM1076NS	558-2C31			
Molding Compound Material		G770HCD	G700LTD			
	Material	Au-Ni-Au	C194			
Load Frama	Paddle Size	43 X 55 mils (1.1x1.4mm)	51 x 67mils (1.3x1.7 mm)			
Lead-Frame	DAP Surface Prep	Au-Ni-Au	PPF			
See attached pre and post change comparison						
Р	ackage	X2DFN	UDFN			

## Impacts to Data Sheet:Yes. Package Outline Drawing (POD).

		Units	Millimeter							
Dimension		Symbol	Uı	nisem PC	)D	UTL POD (UDFN)				
Diriici	131011		Min. Nom. Max			Min.	Nom.	Max		
Body	Х	D	2.0	0.0 ± 0.0	50	2	.00 ± 0.0	5		
size	у	E	2.0	0.0 ± 0.0	50	2.00 ± 0.05				
Exposed	Х	D2	1.400 ± 0.030			1.40 ± 0.05				
Pad	у	E2	1.3	100 ± 0.0	30	1.10 ± 0.05				
Pito	ch	е	0.40 BSC				0.40 BSC			
Overall	Height	Α	-	-	0.40	0.45	0.50	0.55		
Stand	doff	A1	0	-	0.01	0	-	0.050		
Termina	l Width	b	0.200 ± 0.030				0.20 ± 0.05			
Terminal	Length	L	0.200 ± 0.030		0	5				
Terminal	Pullback	L1	0			0.05 REF				
Termir Expose		K	0.23 ± 0.			).23 ± 0.5	0			

# Change ImpactNone

**Reason for Change:**To improve productivity by qualifying UTL as a new assembly site.

**Change Implementation Status:**In Progress

Estimated First Ship Date: November 20, 2023 (date code: 2347)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

		Ju	ly 20	22		>	September 2023				:3	>	November 2023			3	
Workweek	2 7	2 8	2 9	3 0	3 1		35	36	37	38	39		44	45	46	47	48
Initial PCN Issue Date		Χ															
Qual Report Availability											Х						
Final PCN Issue Date											Χ						
Estimated Implementation Date																X	

Method to Identify Change:Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:** July 4, 2022: Issued initial notification.

September 29, 2023: Issued final notification. Attached the Qualification Report. Added change in package code and impact to datasheet. Provided estimated first ship date to be on November 20, 2023.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

### Attachments:

PCN\_LIAL-26JIWI938 Qual Report.pdf PCN\_LIAL-26JIWI938\_Pre\_and\_Post\_Change Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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	e your PCN profile, including opt out, please go to the PCN home page select login yMicrochip account. Select a profile option from the left navigation bar and make ions.

Affected Catalog Part Numbers (CPN)	
MICRF112YMU-TR	